Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

ON Semiconductor
MTP12P10G

For any questions, you can email us directly:
sales@integrated-circuit.com

MTP12P10

Preferred Device

Power MOSFET
12 Amps, 100 Volts

P−Channel TO−220

This Power MOSFET is designed for medium voltage, high speed power switching applications such as switching regulators, converters, solenoid and relay drivers.

Features

- Silicon Gate for Fast Switching Speeds − Switching Times Specified at 100°C
- Designer's Data − I_{DSS}, $V_{DS(on)}$, $V_{GS(th)}$ and SOA Specified at Elevated Temperature
- Rugged − SOA is Power Dissipation Limited
- Source−to−Drain Diode Characterized for Use With Inductive Loads
- Pb−Free Package is Available*

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain−Source Voltage	V_{DSS}	100	Vdc
Drain−Gate Voltage (R_{GS} = 1.0 MΩ)	V_{DGR}	100	Vdc
Gate−Source Voltage − Continuous − Non−repetitive ($t_p \le 50$ μs)	V_{GS} V_{GSM}	±20 ±40	Vdc Vpk
Drain Current − Continuous − Pulsed	I_D I_{DM}	12 28	Adc
Total Power Dissipation Derate above 25°C	P_D	75 0.6	W W/°C
Operating and Storage Temperature Range	T_J, T_{stg}	−65 to 150	°C
Thermal Resistance − Junction−to−Case − Junction−to−Ambient	 $R_{\theta JC}$ $R_{\theta JA}$	 1.67 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8″ from case for 10 seconds	T_L	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

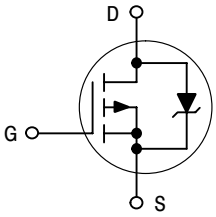
*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor®

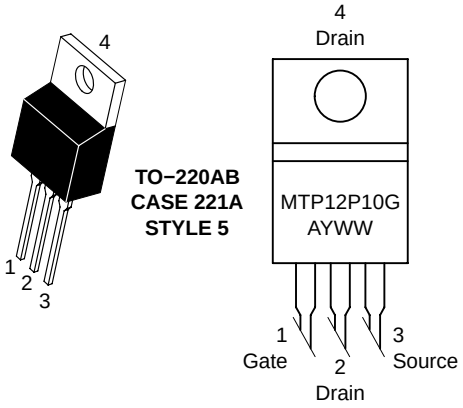
http://onsemi.com

12 AMPERES, 100 VOLTS
$R_{DS(on)}$ = 300 mΩ

P−Channel



MARKING DIAGRAM AND PIN ASSIGNMENT



MTP12P10 = Device Code
A = Location Code
Y = Year
WW = Work Week
G = Pb−Free Package

ORDERING INFORMATION

Device	Package	Shipping
MTP12P10	TO−220AB	50 Units/Rail
MTP12P10G	TO−220AB (Pb−Free)	50 Units/Rail

Preferred devices are recommended choices for future use and best overall value.

MTP12P10

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Drain−Source Breakdown Voltage (V_{GS} = 0, I_D = 0.25 mA)		$V_{(BR)DSS}$	100	−	Vdc
Zero Gate Voltage Drain Current (V_{DS} = Rated V_{DSS}, V_{GS} = 0) (V_{DS} = Rated V_{DSS}, V_{GS} = 0, T_J = 125°C)		I_{DSS}	 − −	 10 100	μAdc
Gate−Body Leakage Current, Forward (V_{GSF} = 20 Vdc, V_{DS} = 0)		I_{GSSF}	−	100	nAdc
Gate−Body Leakage Current, Reverse (V_{GSR} = 20 Vdc, V_{DS} = 0)		I_{GSSR}	−	100	nAdc
ON CHARACTERISTICS (Note 1)					
Gate Threshold Voltage (V_{DS} = V_{GS}, I_D = 1.0 mA) T_J = 100°C		$V_{GS(th)}$	2.0 1.5	4.5 4.0	Vdc
Static Drain−Source On−Resistance (V_{GS} = 10 Vdc, I_D = 6.0 Adc)		$R_{DS(on)}$	−	0.3	Ω
Drain−Source On−Voltage (V_{GS} = 10 V) (I_D = 12 Adc) (I_D = 6.0 Adc, T_J = 100°C)		$V_{DS(on)}$	 − −	 4.2 3.8	Vdc
Forward Transconductance (V_{DS} = 15 V, I_D = 6.0 A)		g_{FS}	2.0	−	mhos
DYNAMIC CHARACTERISTICS					
Input Capacitance	(V_{DS} = 25 V, V_{GS} = 0, f = 1.0 MHz) See Figure 10	C_{iss}	−	920	pF
Output Capacitance		C_{oss}	−	575	
Reverse Transfer Capacitance		C_{rss}	−	200	
SWITCHING CHARACTERISTICS (Note 1) (T_J = 100°C)					
Turn−On Delay Time	(V_{DD} = 25 V, I_D = 0.5 Rated I_D, R_G = 50 Ω) See Figures 12 and 13	$t_{d(on)}$	−	50	ns
Rise Time		t_r	−	150	
Turn−Off Delay Time		$t_{d(off)}$	−	150	
Fall Time		t_f	−	150	
Total Gate Charge	(V_{DS} = 0.8 Rated V_{DSS}, I_D = Rated I_D, V_{GS} = 10 V) See Figure 11	Q_g	33 (Typ)	50	nC
Gate−Source Charge		Q_{gs}	16 (Typ)	−	
Gate−Drain Charge		Q_{gd}	17 (Typ)	−	
SOURCE−DRAIN DIODE CHARACTERISTICS (Note 1)					
Forward On−Voltage	(I_S = Rated I_D, V_{GS} = 0)	V_{SD}	4.0 (Typ)	5.5	Vdc
Forward Turn−On Time		t_{on}	Limited by stray inductance		
Reverse Recovery Time		t_{rr}	300 (Typ)	−	ns
INTERNAL PACKAGE INDUCTANCE (TO−204)					
Internal Drain Inductance, (Measured from the contact screw on the header closer to the source pin and the center of the die)		L_d	5.0 (Typ)	−	nH
Internal Source Inductance (Measured from the source pin, 0.25″ from the package to the source bond pad)		L_s	12.5 (Typ)	−	
INTERNAL PACKAGE INDUCTANCE (TO−220)					
Internal Drain Inductance (Measured from the contact screw on tab to center of die) (Measured from the drain lead 0.25″ from package to center of die)		L_d	 3.5 (Typ) 4.5 (Typ)	 − −	nH
Internal Source Inductance (Measured from the source lead 0.25″ from package to source bond pad)		L_s	7.5 (Typ)	−	

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

MTP12P10

TYPICAL ELECTRICAL CHARACTERISTICS

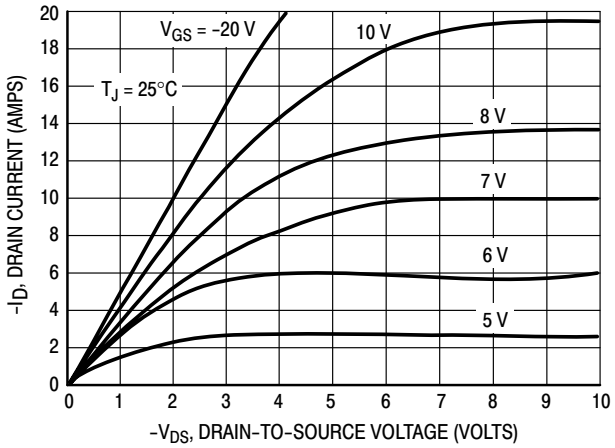


Figure 1. On−Region Characteristics

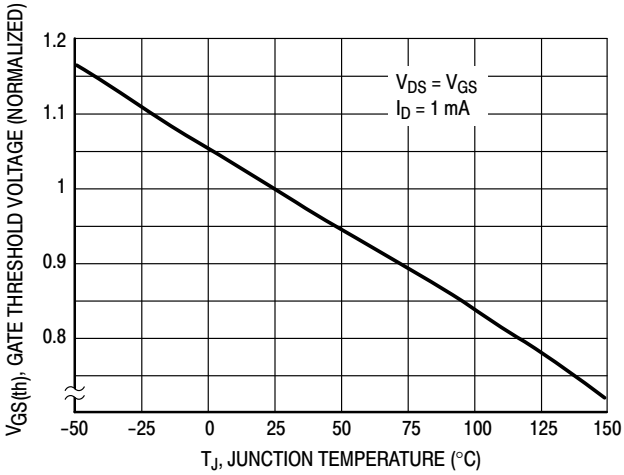


Figure 2. Gate−Threshold Voltage Variation With Temperature

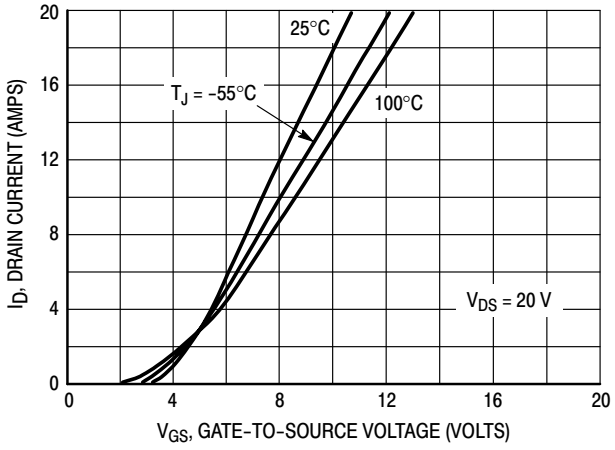


Figure 3. Transfer Characteristics

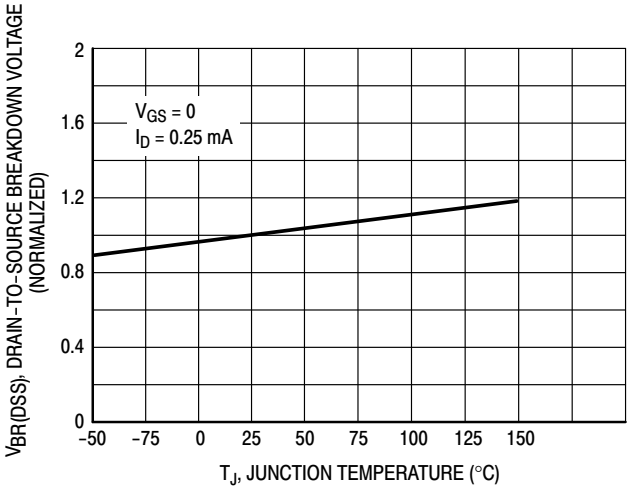


Figure 4. Normalized Breakdown Voltage versus Temperature

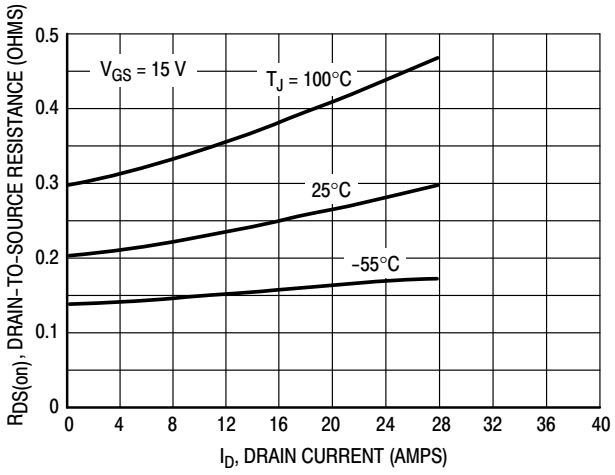


Figure 5. On−Resistance versus Drain Current

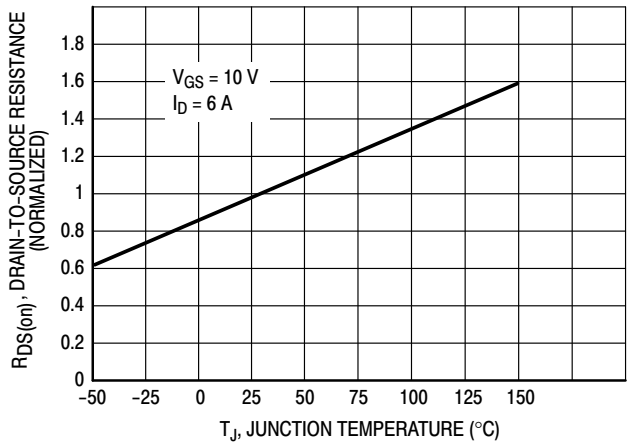


Figure 6. On−Resistance Variation With Temperature

MTP12P10

SAFE OPERATING AREA INFORMATION

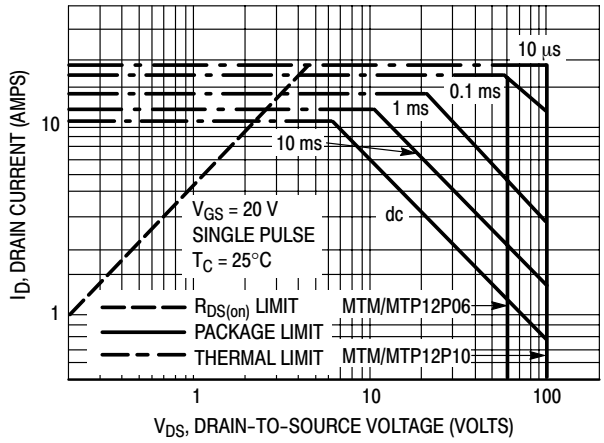


Figure 7. Maximum Rated Forward Biased Safe Operating Area

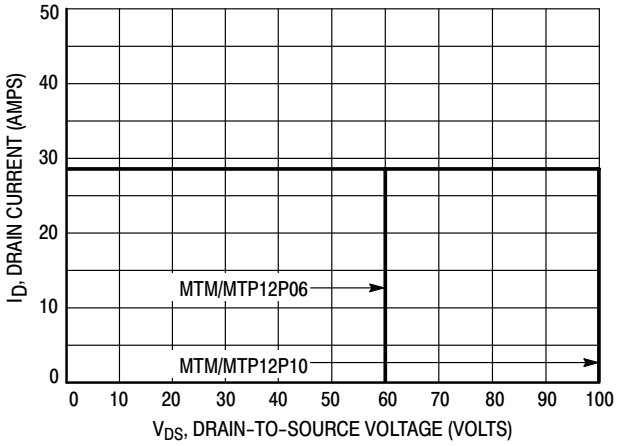


Figure 8. Maximum Rated Switching Safe Operating Area

FORWARD BIASED SAFE OPERATING AREA

The FBSOA curves define the maximum drain−to−source voltage and drain current that a device can safely handle when it is forward biased, or when it is on, or being turned on. Because these curves include the limitations of simultaneous high voltage and high current, up to the rating of the device, they are especially useful to designers of linear systems. The curves are based on a case temperature of 25°C and a maximum junction temperature of 150°C. Limitations for repetitive pulses at various case temperatures can be determined by using the thermal response curves. ON Semiconductor Application Note, AN569, “Transient Thermal Resistance−General Data and Its Use” provides detailed instructions.

SWITCHING SAFE OPERATING AREA

The switching safe operating area (SOA) of Figure 8 is the boundary that the load line may traverse without incurring damage to the MOSFET. The fundamental limits are the peak current, I_{DM} and the breakdown voltage, $V_{(BR)DSS}$. The switching SOA shown in Figure 8 is applicable for both turn−on and turn−off of the devices for switching times less than one microsecond.

The power averaged over a complete switching cycle must be less than:

$$\frac{T_{J(max)} - T_C}{R_{\theta JC}}$$

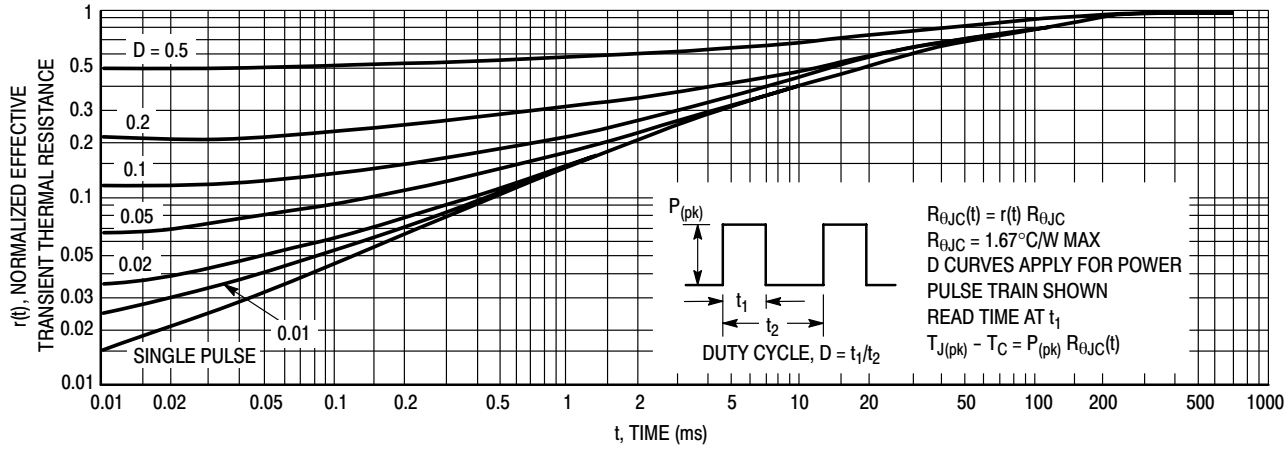


Figure 9. Thermal Response

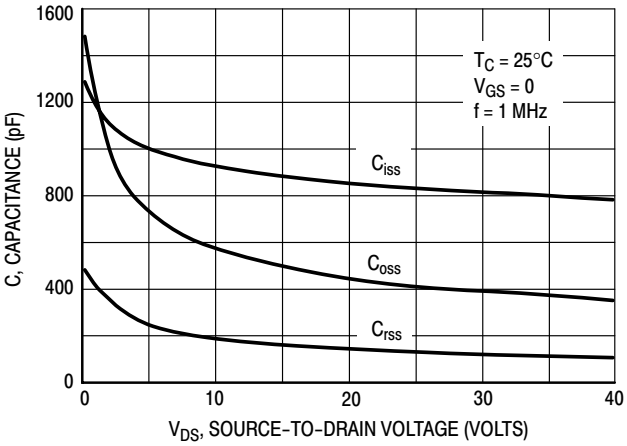


Figure 10. Capacitance Variation

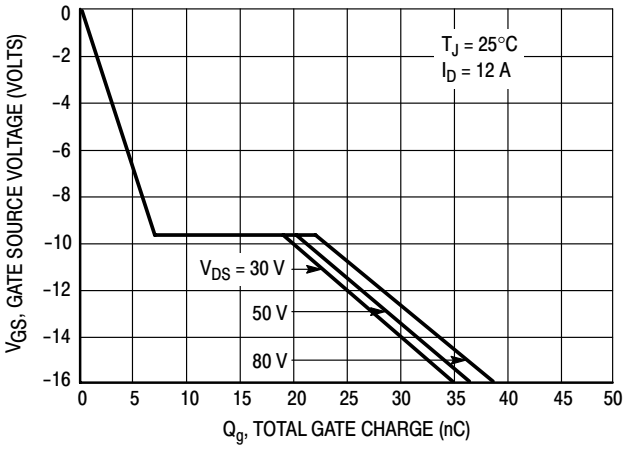


Figure 11. Gate Charge versus Gate−To−Source Voltage

RESISTIVE SWITCHING

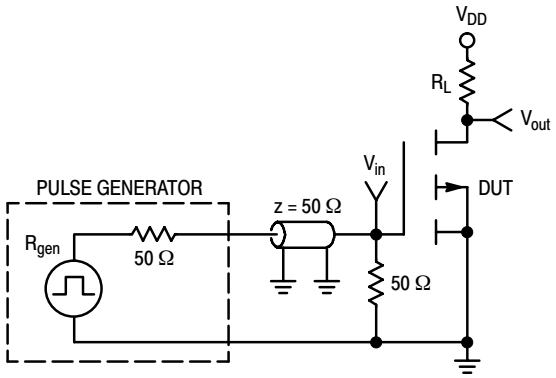


Figure 12. Switching Test Circuit

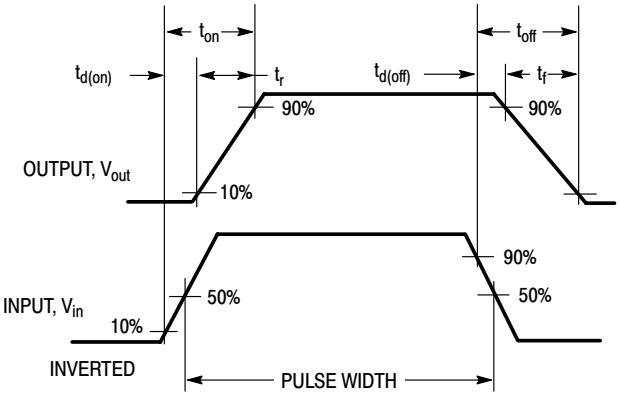
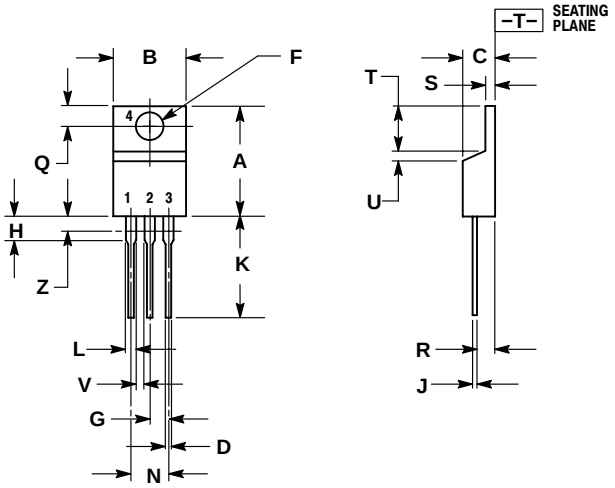


Figure 13. Switching Waveforms

MTP12P10

PACKAGE DIMENSIONS

TO−220
CASE 221A−09
ISSUE AB



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.020	0.055	0.508	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 5:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303−675−2175 or 800−344−3860 Toll Free USA/Canada
Fax: 303−675−2176 or 800−344−3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800−282−9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81−3−5773−3850

ON Semiconductor Website: **www.onsemi.com**

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

MTP12P10/D